

Global SiC Wafer Laser Cutting Equipment Market 2024 by Manufacturers, Regions, Type and Application, Forecast to 2030

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Abstracts

According to our (Global Info Research) latest study, the global SiC Wafer Laser Cutting Equipment market size was valued at USD 94 million in 2023 and is forecast to a readjusted size of USD 257.8 million by 2030 with a CAGR of 15.6% during review period.

Silicon carbide (SiC) was discovered in 1893 as an industrial abrasive for grinding wheels and automotive brakes. The scheme of laser cutting silicon carbide is laser modified cutting technology. The principle is to use a laser beam with a high transmission wavelength to focus on the inside of the wafer through a lens, and multiphoton absorption occurs, resulting in a local deformation layer, namely modified layer. The layer is mainly composed of holes, high dislocation density layers and cracks. The modified layer is the starting point of subsequent wafer dicing and cracking. The modified layer can be confined inside the wafer by optimizing the laser and optical path system, and no thermal damage is caused to the surface and bottom of the wafer. Then, use external force to guide the cracks to the surface and bottom of the wafer, separating the wafer into the required size.

Global key players of SiC wafer laser cutting equipment include DISCO Corporation, SuZhou Delphi Laser and Han's Laser, etc. The top three players hold a share over 60%. From the perspective of consumption value by region? Asia-Pacific (excluding China) is the largest market of SiC wafer laser cutting equipment, followed by China, North America, and Europe. In terms of type, processing sizes up to 6 Inches account for more than 75% of the market share. In terms of application, foundry has a share over 60 %.

The Global Info Research report includes an overview of the development of the SiC Wafer Laser Cutting Equipment industry chain, the market status of Foundry (Processing Sizes up to 6 Inches, Processing Sizes up to 8 Inches), IDM (Processing Sizes up to 6 Inches, Processing Sizes up to 8 Inches), and key enterprises in developed and developing market, and analysed the cutting-edge technology, patent, hot applications and market trends of SiC Wafer Laser Cutting Equipment.

Regionally, the report analyzes the SiC Wafer Laser Cutting Equipment markets in key regions. North America and Europe are experiencing steady growth, driven by government initiatives and increasing consumer awareness. Asia-Pacific, particularly China, leads the global SiC Wafer Laser Cutting Equipment market, with robust domestic demand, supportive policies, and a strong manufacturing base.

Key Features:

The report presents comprehensive understanding of the SiC Wafer Laser Cutting Equipment market. It provides a holistic view of the industry, as well as detailed insights into individual components and stakeholders. The report analysis market dynamics, trends, challenges, and opportunities within the SiC Wafer Laser Cutting Equipment industry.

The report involves analyzing the market at a macro level:

Market Sizing and Segmentation: Report collect data on the overall market size, including the sales quantity (Units), revenue generated, and market share of different by Type (e.g., Processing Sizes up to 6 Inches, Processing Sizes up to 8 Inches).

Industry Analysis: Report analyse the broader industry trends, such as government policies and regulations, technological advancements, consumer preferences, and market dynamics. This analysis helps in understanding the key drivers and challenges influencing the SiC Wafer Laser Cutting Equipment market.

Regional Analysis: The report involves examining the SiC Wafer Laser Cutting Equipment market at a regional or national level. Report analyses regional factors such as government incentives, infrastructure development, economic conditions, and consumer behaviour to identify variations and opportunities within different markets.

Market Projections: Report covers the gathered data and analysis to make future projections and forecasts for the SiC Wafer Laser Cutting Equipment market. This may

include estimating market growth rates, predicting market demand, and identifying emerging trends.

The report also involves a more granular approach to SiC Wafer Laser Cutting Equipment:

Company Analysis: Report covers individual SiC Wafer Laser Cutting Equipment manufacturers, suppliers, and other relevant industry players. This analysis includes studying their financial performance, market positioning, product portfolios, partnerships, and strategies.

Consumer Analysis: Report covers data on consumer behaviour, preferences, and attitudes towards SiC Wafer Laser Cutting Equipment. This may involve surveys, interviews, and analysis of consumer reviews and feedback from different by Application (Foundry, IDM).

Technology Analysis: Report covers specific technologies relevant to SiC Wafer Laser Cutting Equipment. It assesses the current state, advancements, and potential future developments in SiC Wafer Laser Cutting Equipment areas.

Competitive Landscape: By analyzing individual companies, suppliers, and consumers, the report presents insights into the competitive landscape of the SiC Wafer Laser Cutting Equipment market. This analysis helps understand market share, competitive advantages, and potential areas for differentiation among industry players.

Market Validation: The report involves validating findings and projections through primary research, such as surveys, interviews, and focus groups.

Market Segmentation

SiC Wafer Laser Cutting Equipment market is split by Type and by Application. For the period 2019-2030, the growth among segments provides accurate calculations and forecasts for consumption value by Type, and by Application in terms of volume and value.

Market segment by Type

Processing Sizes up to 6 Inches

Processing Sizes up to 8 Inches

Market segment by Application

Foundry

IDM

Major players covered

DISCO Corporation

Suzhou Delphi Laser Co

Han's Laser Technology

3D-Micromac

Synova S.A.

HGTECH

ASMPT

GHN.GIE

Wuhan DR Laser Technology

Market segment by region, regional analysis covers

North America (United States, Canada and Mexico)

Europe (Germany, France, United Kingdom, Russia, Italy, and Rest of Europe)

Asia-Pacific (China, Japan, Korea, India, Southeast Asia, and Australia)

South America (Brazil, Argentina, Colombia, and Rest of South America)

Middle East & Africa (Saudi Arabia, UAE, Egypt, South Africa, and Rest of Middle East & Africa)

The content of the study subjects, includes a total of 15 chapters:

Chapter 1, to describe SiC Wafer Laser Cutting Equipment product scope, market overview, market estimation caveats and base year.

Chapter 2, to profile the top manufacturers of SiC Wafer Laser Cutting Equipment, with price, sales, revenue and global market share of SiC Wafer Laser Cutting Equipment from 2019 to 2024.

Chapter 3, the SiC Wafer Laser Cutting Equipment competitive situation, sales quantity, revenue and global market share of top manufacturers are analyzed emphatically by landscape contrast.

Chapter 4, the SiC Wafer Laser Cutting Equipment breakdown data are shown at the regional level, to show the sales quantity, consumption value and growth by regions, from 2019 to 2030.

Chapter 5 and 6, to segment the sales by Type and application, with sales market share and growth rate by type, application, from 2019 to 2030.

Chapter 7, 8, 9, 10 and 11, to break the sales data at the country level, with sales quantity, consumption value and market share for key countries in the world, from 2017 to 2023. and SiC Wafer Laser Cutting Equipment market forecast, by regions, type and application, with sales and revenue, from 2025 to 2030.

Chapter 12, market dynamics, drivers, restraints, trends and Porters Five Forces analysis.

Chapter 13, the key raw materials and key suppliers, and industry chain of SiC Wafer Laser Cutting Equipment.

Chapter 14 and 15, to describe SiC Wafer Laser Cutting Equipment sales channel, distributors, customers, research findings and conclusion.

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